

Vishay General Semiconductor

# Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier





Available	

PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	2 A			
V <sub>RRM</sub>	60 V			
I <sub>FSM</sub>	60 A			
V <sub>F</sub> at I <sub>F</sub> = 2 A (125 °C)	0.46 V			
T <sub>J</sub> max.	175 °C			
Package	SlimSMAW (DO-221AD)			
Circuit configuration	Single			

### **FEATURES**

- Low-profile package
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code: base P/NHM3
- FREE Compatible to SOD-128 package case outline
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

## **TYPICAL APPLICATIONS**

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

## **MECHANICAL DATA**

Case: SlimSMAW (DO-221AD) Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 gualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

<b>MAXIMUM RATINGS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)				
PARAMETER	SYMBOL	VSS8D2M6	UNIT	
Device marking code		V2M6		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	60	V	
Maximum average forward rectified current (fig.1)	I <sub>F(AV)</sub> <sup>(1)</sup>	2	А	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	60	A	
Operating junction temperature range	T <sub>J</sub> <sup>(3)</sup>	-40 to +175		
Storage temperature range	T <sub>STG</sub>	-55 to +175		

Notes

<sup>(1)</sup> Free air, mounted on recommended copper pad area

 $^{(2)}$  The heat generated must be less than the thermal conductivity from junction-to-ambient: dP<sub>D</sub>/dT<sub>J</sub> < 1/R<sub>0JA</sub>



RoHS

COMPLIANT

HALOGEN





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<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CO	TEST CONDITIONS		TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 1 A	$\begin{array}{c} I_F = 1 \text{ A} \\ \hline I_F = 2 \text{ A} \end{array}  T_A = 25 \text{ °C} \end{array}$		0.48	-	- V
	$I_F = 2 A$		V <sub>E</sub> (1)	0.54	0.62	
	I <sub>F</sub> = 1 A	– T <sub>A</sub> = 125 °C	VF ()	0.36	-	
	I <sub>F</sub> = 2 A		C	0.46	0.54	
Reverse current	V - 60 V	T <sub>A</sub> = 25 °C T <sub>A</sub> = 125 °C	I <sub>R</sub> <sup>(2)</sup>	-	0.2	mA
	V <sub>R</sub> = 60 V		'R (=)	1.5	5.0	
Typical junction capacitance	4.0 V, 1 MH	4.0 V, 1 MHz		430	-	pF

#### Notes

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

<sup>(2)</sup> Pulse test: pulse width  $\leq$  5 ms

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise specified)				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Typical thermal resistance	R <sub>0JA</sub> <sup>(1)(2)</sup>	120	150	°C/W
	R <sub>θJM</sub> <sup>(3)</sup>	12	15	0/11

#### Notes

 $^{(1)}$  The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ 

(2) Thermal resistance junction-to-ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz., standard footprint

(3) Thermal resistance junction-to-mount to follow JEDEC 51-14 transient dual interface test method (TDIM)

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
VSS8D2M6-M3/H	0.033	Н	3500	7" diameter plastic tape and reel	
VSS8D2M6-M3/I	0.033	I	14 000	13" diameter plastic tape and reel	
VSS8D2M6HM3/H (1)	0.033	Н	3500	7" diameter plastic tape and reel	
VSS8D2M6HM3/I <sup>(1)</sup>	0.033	Ι	14 000	13" diameter plastic tape and reel	

#### Note

(1) AEC-Q101 qualified



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## **RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25$ °C unless otherwise noted)

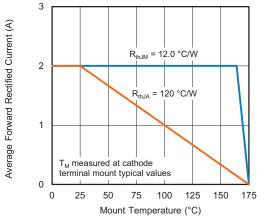


Fig. 1 - Maximum Forward Current Derating Curve

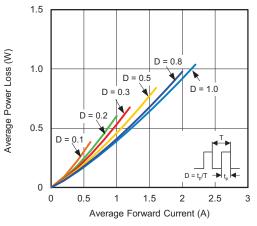


Fig. 2 - Forward Power Loss Characteristics

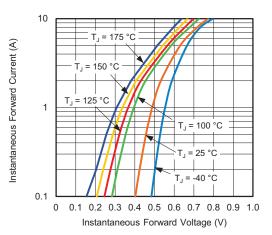


Fig. 3 - Typical Instantaneous Forward Characteristics

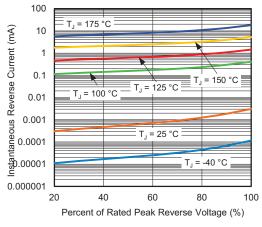


Fig. 4 - Typical Reverse Leakage Characteristics

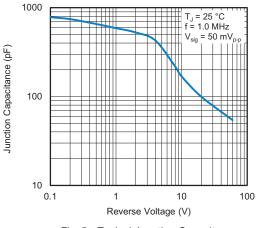


Fig. 5 - Typical Junction Capacitance

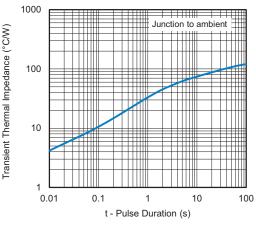


Fig. 6 - Typical Transient Thermal Impedance

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3

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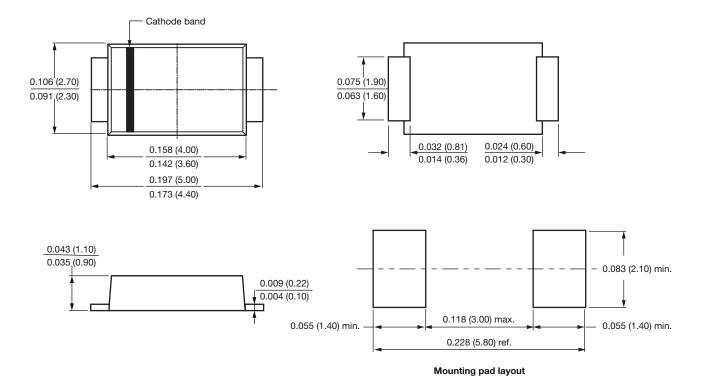


# VSS8D2M6

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### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

SlimSMAW (DO-221AD)





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